

CALL FOR PAPERS

IMPORTANT DATES

April 22st, 2024

New Deadline Paper Submission

June 09th, 2024

Notification of Acceptance

June 30th, 2024

Camera Ready Submission

**September 11th-14th,
2024**

Conference Date

CONFERENCE COMMITTEES

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Information and registrations

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ANDESCON is the biannual Technical and Scientific Conference of the Andean Council of the IEEE that brings together IEEE professionals and scientists from the Andean countries. The twelfth edition of this IEEE event will be held in the wonderful city of Cusco, Perú. The ANDESCON conference is an opportunity for professional members, academics, researchers and industrialists to will meet and present the developments and technological advances that move the Andean region countries.

CUSCO: The Heart of the Inca Empire, is a fascinating city located in the Southern Sierras, Cusco is a UNESCO World Heritage Site and is one of Peru most visited cities as it is the largest and most comfortable city from which tourists can visit Machu Picchu (one of the 7 wonders of the world), the Sacred Valley of the and other Inca sites in the region Peru has many additional treasures to visit (<http://peru.travel/>).

TOPICS OF INTEREST

but not limited to

- » Circuits, Systems and Electron Devices
- » Computational Intelligence
- » Education in Engineering
- » Industrial Electronics
- » Robotics and Automation Systems
- » Smart Cities and Smart Mobility
- » Technology & Engineering Management
- » Communications
- » Computer and Software Engineering
- » Engineering in Medicine and Biology
- » Power and Energy
- » Signal Processing & Aerospace
- » Systems and Control
- » Mechanics and materials

PAPER SUBMISSION

The articles must be submitted in digital format (PDF) through the paper submission page. Papers must be written in English. Papers must use the IEEE conference format. The maximum length is six (6) pages per article including illustrations and references.

URL: <https://easychair.org/conferences/?conf=2024ieeeandescon>

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